

Recent News



QP Technologies™ Sees Double-Digit Growth, Expands Team and Offerings to Meet Customer Needs



QP Technologies' Bill Lawrence Leads Exclusive Webinar with CMC Microsystems



Semiconductor Engineering Round
Table with Dick Otte: Challenges
With Chiplets and Packaging

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Upcoming Events

iMAPS (San Diego)

October 12 - 14, 2021

Join us at the 54th International Symposium on Microelectronics in San Diego. QP Technologies is a keynote sponsor for iMAPS 2021 and our team is looking forward to connecting with other experts in the microelectronics field. Click the link below to request a meeting with our team at iMAPS.

REQUEST MEETING

About QP Technologies

QP Technologies is a leading provider of microelectronic packaging and assembly, wafer preparation, and substrate design and development services. We leverage proven technologies developed by our skilled staff, and we work closely with you to get your products to market quickly, with the highest quality prototype and production volumes.

Connect with Us



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